

Bandpass Filter

BFHKI-1572+

50Ω 13.9 to 17.5 GHz

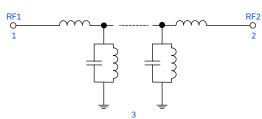
THE BIG DEAL

- · LTCC Band Pass Filter with Integrated Interposer Board
- Wide Stopband Rejection, Typ. 42 dB up to 40 GHz
- Small Size, 4.95 mm x 3.65 mm
- Shielded Construction
- Protected by US Patents 11,638,370 and 11,744,057



Generic photo used for illustration purposes only

FUNCTIONAL DIAGRAM



APPLICATIONS

Test & Measurement Equipment

PRODUCT OVERVIEW

BFHKI-1572+ is a miniature low temperature co-fired ceramic (LTCC) ultra-high stopband rejection band pass filter with a 13.9 to 17.5 GHz passband supporting a variety of applications. This model achieves 42 dB typical stopband rejection up to 40 GHz, when mounted on coplanar waveguide layouts. Housed in a small 4.95 mm by 3.65 mm ceramic form factor, the filter is ideal for dense signal chain PCB layouts where it complements MMIC size and performance. The BFHKI family with integrated interposer board enables installation onto PCB layouts with automated manufacturing equipment. This model provides 3.2 dB typical insertion loss over a wide band due to its rugged monolithic construction. The LTCC fabrication process assures minimal RF performance variation while delivering a product that is well suited for environmental extremes of high humidity and temperature.

KEY FEATURES

Features	Advantages			
Surface mountable due to Integrated Interposer Board	Enables installation with automated manufacturing equipment making this suitable for high-volume processes.			
Wide Rejection	Provides high stopband rejection of 42 dB typical up to 40 GHz. Additional support for alternate PCB layouts is available by contacting Mini-Circuits Applications team.			
Small size (4.95 mm x 3.65 mm)	Allows for high layout density of circuit boards, while minimizing effects of parasitics.			
Wide operating and storage temperature, -55 to 125°C	Enables use in high reliability and extreme environment condition such as aerospace & defense applications.			
Cost effective	LTCC is a scalable technology that is cost effective due to ease of production in high-volume			

REV. OR ECO-018272 BFHKI-1572+ MCL NY 231020



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ELECTRICAL SPECIFICATIONS^{1,2,3} AT +25°C

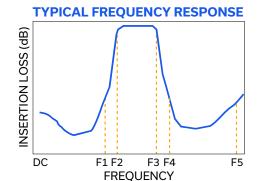
Parameter		F#	Frequency (GHz)	Min.	Тур.	Max.	Units
	Center Frequency ⁴	_	_	_	15.7	_	GHz
Passband	Insertion Loss	F2-F3	13.9 - 17.5	_	3.2	4.0	dB
	Return Loss	F2-F3	13.9 - 17.5	_	8	_	dB
Stop Band, Lower	Rejection	DC-F1	0.1 - 10.3	55	65	_	dB
Stop Band, Upper	Rejection	F4-F5	21.3 - 40	27	42	_	dB

- 1. Tested on Evaluation Board P/N TB-BFHKI-1572C+. Measured with the connector and feedline effects de-embedded using the 2XThru IEEE P370 method.
- 2. Bi-directional RF1 and RF2 ports can be interchanged.
- 3. This component should not be used as a DC-block. In applications where DC voltage and/or current is present at either the input or output ports, external DC blocking capacitors are required.
- 4. Typical variation ± 5%

ABSOLUTE MAXIMUM RATINGS⁵

Parameter	Ratings
Operating Temperature	-55 °C to +125 °C
Storage Temperature	-55 °C to +125 °C
Input Power ⁶	1W

- 5. Permanent damage may occur if any of these limits are exceeded.
- 6. Power rating applies only to signals within the passband. Power rating above +25°C operating temperature decreases linearly to 0.5 W at +125°C.

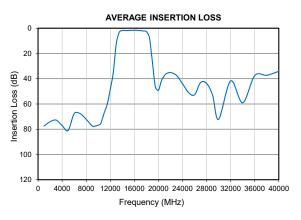


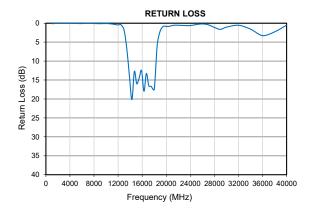
Bandpass Filter

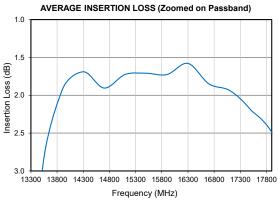
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TYPICAL PERFORMANCE GRAPHS







Bandpass Filter

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FUNCTIONAL DIAGRAM

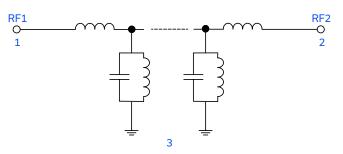
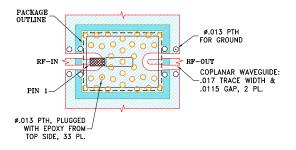


Figure 1. BFHKI-1572+ Functional Diagram

PAD DESCRIPTION

Function	Pad Number	Description			
RF1 ^(Note 2)	1	Connects to RF Input Port			
RF2 ^(Note 2)	2	Connects to RF Output Port			
GROUND	3	Connects to Ground on PCB, (See drawing PL-753)			

SUGGESTED PCB LAYOUT (PL-753)



NOTES:

- 1. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR ROGERS RO4350B
 WITH DIELECTRIC THICKNESS .010"; COPPER: 1/2 OZ.
 FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB ARE CONTINUOUS GROUND PLANE.
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 DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

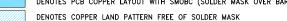
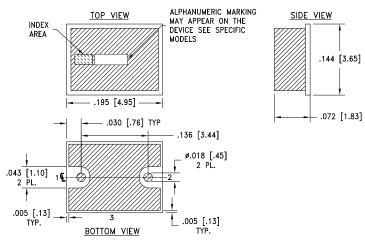


Figure 2. Suggested PCB Layout BFHKI-1572+

CASE STYLE DRAWING





Weight: .135 grams.

Dimensions are in inches [mm]. Tolerances: 2 Pl.±.01; 3 Pl. ±.005

PRODUCT MARKING*: F470

*Marking may contain other features or characters for internal lot control.



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ADDITIONAL DETAILED INFORMATION IS AVAILABLE ON OUR DASH BOARD.

CLICK HERE

	Data				
Performance Data & Graphs	Graphs				
	S-Parameter (S2P Files) Data Set (.zip file) De-embedded to device pads				
Case Style	NM3237 Finish: Gold over Nickel Plating				
RoHS Status	Compliant				
Tape and Reel	TR-F77				
Suggested Layout for PCB Design	PL-753				
Evaluation Board	TB-BFHKI-1572C+				
Evaluation Doalu	Gerber File				
Environmental Rating	ENV06T12				

NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuits' applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits' standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html



LTCC Bandpass Filter

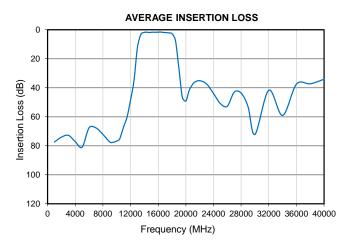
BFHKI-1572+

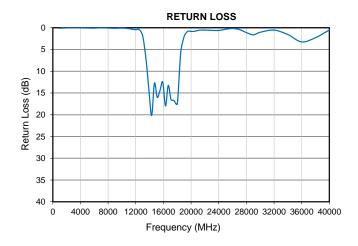
Typical Performance Data

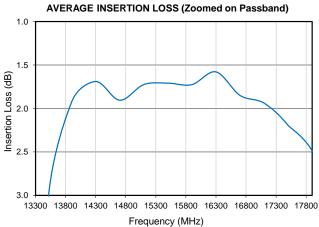
FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
1000	77.40	0.12
2000	74.08	0.04
3000	72.78	0.03
4000	77.14	0.04
5000	80.96	0.07
6000	67.64	0.09
7000	67.67	0.00
8000	72.14	0.08
9000	77.40	0.12
9500	77.57	0.09
10300	76.12	0.10
10500	74.50	0.12
11000	66.91	0.21
11500	60.16	0.34
12000	48.51	0.45
12500	35.10	0.43
13000	12.18	1.85
13500	3.14	7.49
13900	1.93	14.31
14300	1.69	20.16
14700	1.90	12.73
15100	1.72	15.99
15500	1.71	14.46
15900	1.73	12.47
16300	1.58	17.98
16700	1.85	13.27
17100	1.94	16.52
17500	2.19	16.68
18000	2.69	17.52
18500	7.37	5.79
19000	26.83	2.02
19500	46.62	0.84
20000	49.23	0.85
20500	41.69	0.81
21000	37.56	0.62
21300	36.04	0.54
22000	35.13	0.53
23000	37.34	0.61
24000	43.92	0.62
25000	43.92 50.95	0.82
26000	52.72	0.35
27000	43.09	0.16
28000	43.68	1.11
29000	53.03	1.63
30000	72.17	1.04
32000	41.70	0.54
34000	59.08	1.56
36000	37.52	3.26
38000	37.29	2.29
40000	34.13	0.52



Typical Performance Data





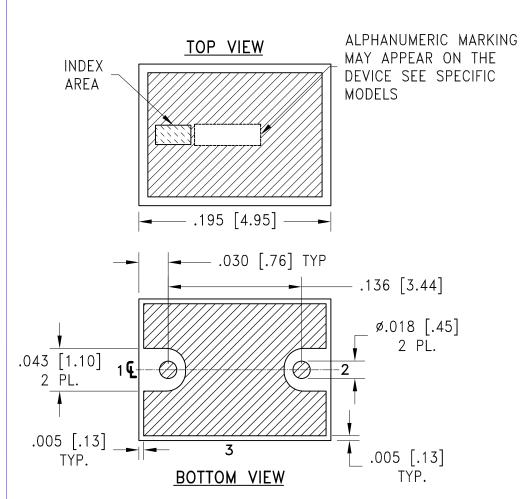


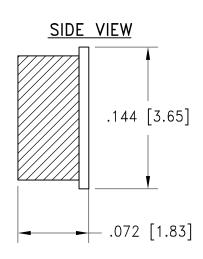


NM

Outline Dimensions

NM3237







Weight: .135 grams.

Dimensions are in inches (mm). Tolerances: 2 Pl.±.01; 3 Pl. ±.005

Notes:

1. Case material: LTCC on printed circut board base.

2. Termination Finish: as shown below or indicated on Data Sheet.
For RoHS Case Styles: Gold Plate over Nickel plate. All models, (+) suffix.



INTERNET http://www.minicircuits.com

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

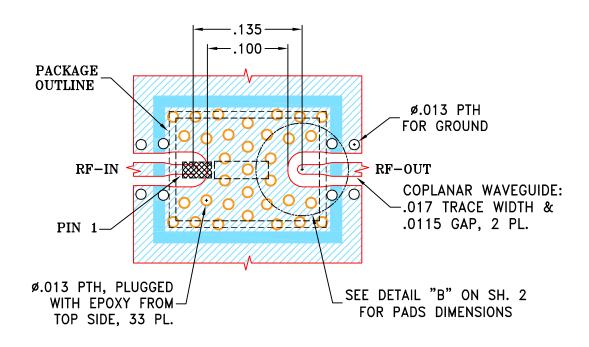
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THIRD ANGLE PROJECTION

	REVISIONS							
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH			
OR	ECO-017025	NEW RELEASE	03/30/23	ITG	IL			
OR1	ECO-018201	CORRECTED TYPO IN NOTE 2	06/16/23	ITG	IL			
A	ECO-020890	ADDED DETAIL "A" (SH.2) & DIMENSIONS	02/16/24	ITG	IL			

SUGGESTED MOUNTING CONFIGURATION FOR NM3237 CASE STYLE



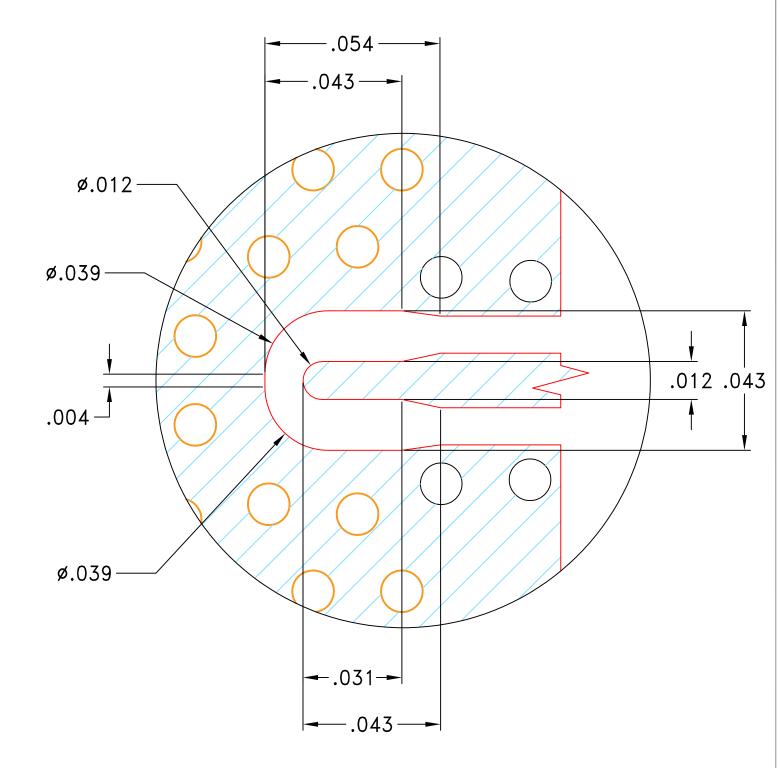
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- 2. BOTTOM SIDE OF THE PCB ARE CONTINUOUS GROUND PLANE.

ASHEETA1.DWG REV:A DATE:01/12/95

DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)

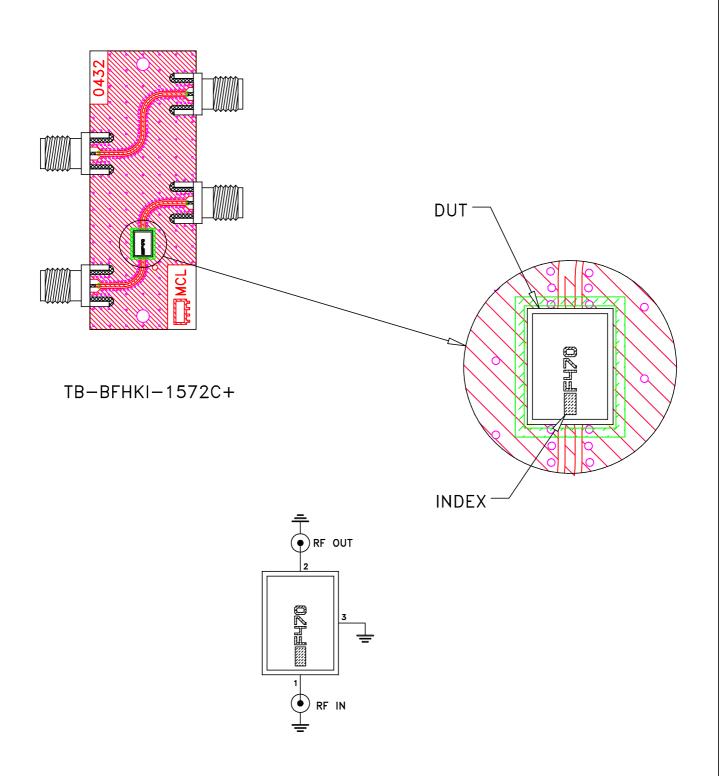
DE	NOTES (COPPER LA	AND PATTE	RN FRE	E OF SOLDE	R MASK					
UNLESS OTHERWISE SPECIFIED		INITIALS	DATE			. ~:		• 4 R			
DIMENSIONS ARE IN INCHES	DRAWN	ITG	03/30/23		\sqcup Mini	i-Cir	'cu	1ts 13.1	Neptu	ne Aver NY 112	nue
TOLERANCES ON: 2 PL DECIMALS ±	CHECKED	GF	03/30/23		Τ			Broc	окіуп	NI 117	೭35
3 PL DECIMALS ± .005 ANGLES ±	APPROVED	IL	03/30/23								
FRACTIONS ±					PL.	NM323	37. ^r	$\Gamma B - 120$	00		
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	ASHEETA1.DWG REV:A DATE:01/12/95			5	OLLIOO	1	J. I		1	OI.	~



DETAIL "A". SOLDER MASK IS NOT SHOWN FOR CLARITY

(SCALE 4:1)

Evaluation Board and Circuit



Schematic Diagram

Notes:

- 1. SMA Female connectors.
- 2. PCB Material: Rogers RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.010 inch.

III Mini-Circuits®



ENV06T12



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 125° C Ambient Environment	Individual Model Data Sheet
Thermal Cycling	-55 to 125°C, 100 cycles, Dwell Time 15 minutes.	MIL-STD-202, Method 107, Condition A-3
Humidity	85°C, 90-95% Relative Humidity, 250hours	
Solderability	10X / 30X Magnification	J-STD-002C Test S, J-STD-002C Test S1
High Temp Storage	125°C, 250 hours	
Bend Test	1mm, deflection for 5 seconds Span of bending: 2.75"	

ENV06T12Rev: OR

06/27/23

DCO-1237 File: ENV06T12.pdf